

ZXSBMR16PT8

SCHOTTKY BRIDGE RECTIFIER PLUS FREEWHEEL DIODE

Product Summary

- Schottky Bridge and Freewheel diode for use in MR16 LED Drive
- Internal Ambient Temperature = 90°C MAX within MR16 circuit enclosure
- V_R = 13.2V_{RMS}
- $I_F = 0.4A_{AVG}$
- $I_R = 10 \mu A$

Description and Applications

This low leakage Schottky bridge and freewheel diode have been specifically designed for the MR16 LED driver solution alongside ZXLD1350E5 as described in Design Note DN86.

Features and Benefits

- Compact surface mount solution and reduced component count in MR16 LED drive circuit
- Optimized bridge and freewheel diode for use in MR16 LED diode circuitry
- Low V_F and low reverse leakage current
- Qualified to AEC-Q101 Standards for High Reliability

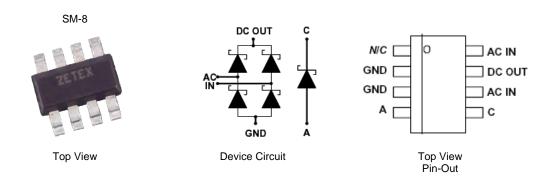
Mechanical Data

Case: SM-8

Case Material: TBDMoisture Sensitivity: TBD

Terminals: TBD

Weight: TBD grams (approximate)

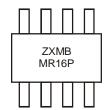


Ordering Information (Note 1)

Device	Packaging	Shipping	
ZXSBMR16PT8TA	SM-8	1000/Tape & Reel	

Notes: 1. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information



ZXSBMR16P = Product Type Marking Code



Maximum Ratings @TA = 25°C unless otherwise specified

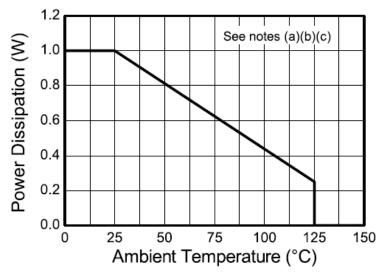
Characteristic		Symbol	Value	Units
Maximum Repetitive Reverse Voltage		V _{RRM}	40	V
Maximum RMS Bridge Input Voltage		V _{RMS}	13.2	V
Average Rectified Forward Current (Notes 2 & 3)		I _{F(AV)}	0.4	Α
Peak Repetitive Forward Current		I _{FPK}	3.5	Α
Non Repetitive Forward Current	t ≤ 100μs	1	13	А
	t ≤ 10ms	IFSM	3.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, T _A = 25°C (Note 2)	P _D	1	W
Thermal Resistance, Junction to Ambient (Note 2)	$R_{\theta JA}$	125	°C/W
Junction Temperature, Forward Dissipation Only	TJ	150	°C
Junction Temperature, Reverse Dissipation (Notes 2, 3, & 4)	TJ	125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
MR16 LED Internal Ambient Temperature (Note 4)	T _A	90	°C

Notes:

- For a bridge mounted on1.6mm FR4 PCB with minimum copper pads and track dimensions in still air.
 Supply 12V RMS with capacitive bridge load.
 Maximum bridge operating junction temperature must be reduced with increased reverse bias voltage to maintain unconditional thermal stability.
 Refer to Design Note DN86



Package Thermal Characteristic

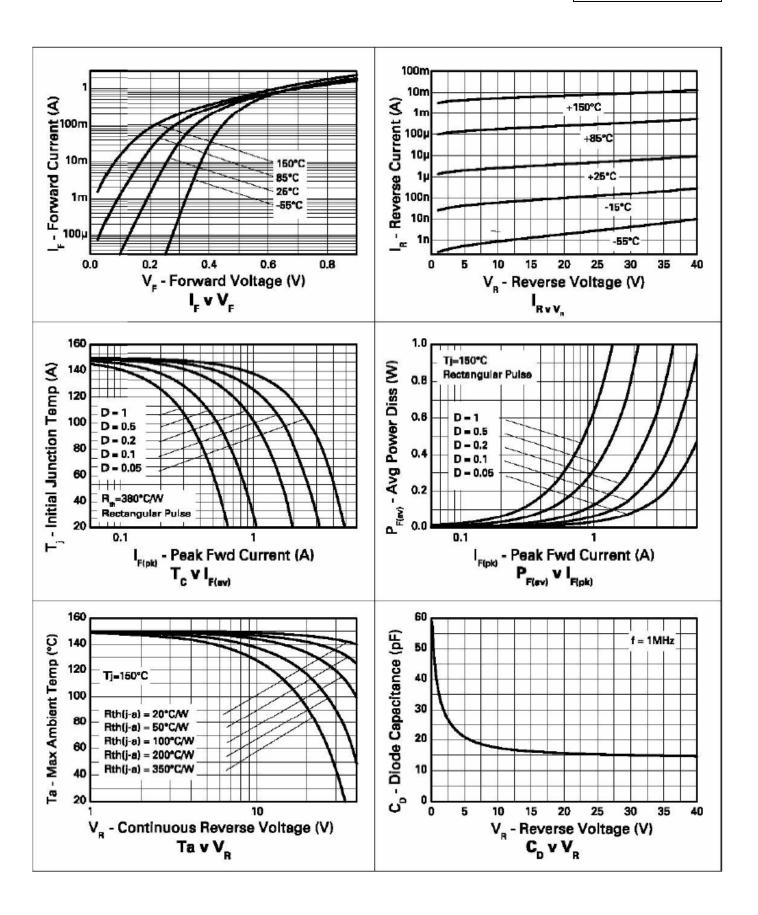


Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	40	-	-	V	$I_R = 200 \mu A$
		-	305	360	mV	$I_F = 50 \text{mA}$
		-	355	410		$I_F = 100 \text{mA}$
		-	405	470		$I_F = 250 \text{mA}$
Forward Voltage (Note 4)	VF	-	485	550		I _F = 500mA
		-	570	660		I _F = 750mA
		-	640	750		I _F = 1A
		-	415	-		$I_F = 500 \text{mA}, T_A = 100 ^{\circ}\text{C}$
Reverse Current	_	-	6	10	μА	$V_R = 30V$
Reverse Current	I _R	-	370	-		$V_R = 30V, T_A = 85^{\circ}C$
Diode Capacitance	C _D	-	16	-	pF	$f = 1MHz$, $V_R = 30V$
Reverse Recovery Time	trr	-	3	-	ns	Switched from $I_F = 100$ mA to $I_R = 100$ mA
Reverse Recovery Charge	Qrr	-	210	-	рС	Measured @ I_R = 10mA di/dt = 500mA/ns. R_{source} = 6Ω ; R_{load} = 10 Ω

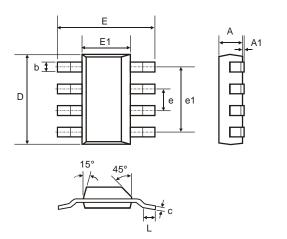
Notes: 4. Measured under pulsed conditions. Pulse width = $300\mu S$. Duty cycle $\leq 2\%$.





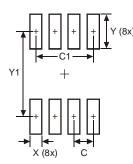


Package Outline Dimensions



SM-8					
Dim	Min	Max	Тур		
Α	_	1.7	-		
A1	0.02	0.1	-		
b	_	0.7	-		
С	0.24	0.32	_		
D	6.3	6.7	-		
е	-	-	1.53		
e1	-	-	4.59		
E	6.7	7.3	_		
E1	3.3	3.7	_		
L	0.9	_	-		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
С	1.52
C1	4.6
Х	0.95
Y	2.80
Y1	6.80



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